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ATTY DOCKET NO. SERIAL NO. Form PTO 1449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE 211618US99 TRED 515 (Modified) 09/910,753 APPLICANT LIST OF REFERENCES CITED BY APPLICANT Rudy M. EMRICK, et al. FILING DATE GROUP July 24, 2001 2826 **U.S. PATENT DOCUMENTS** CLASS **EXAMINER** DOCUMENT DATE SUB NAME FILING DATE INITIAL NUMBER **CLASS** IF APPROPRIATE il. 7 3,802,967 04/09/74 Ladany et al. 4,174,422 ΑB 11/13/79 Matthews et al. 4,404,265 09/13/83 Manasevit AC AD 4,482,906 11/13/84 Hovel et al. AE 4,523,211 06/11/85 Morimoto et al. AF 4,661,176 04/28/87 Manasevit AG 4,793,872 12/27/88 Meunier et al. 07/11/89 ΑН 4,846,926 Kay et al. AJ 4,855,249 08/08/89 Akasaki et al. 01/02/90 ΑI 4.891.091 Shastry 4,912,087 Aslam et al. AK 03/27/90 05/22/90 AL 4,928,154 Umeno et al. AΜ 4,963,949 10/16/90 Wanlass et al. ĀΝ 5,141,894 08/25/92 Bisaro et al. AO 5,159,413 10/27/92 Calviello et al. ĀΡ 5,173,474 12/22/92 Connell et al. AQ 5,221,367 06/22/93 Chisholm et al. AR 07/06/93 5,225,031 McKee et al. AS 5.358.925 10/25/94 Neville Connell et al. AT 5,393,352 02/28/95 Summerfelt ΑU 5,418,216 05/23/95 Fork 5,450,812 09/19/95 Δ McKee et al. ΔW 5,478,653 12/26/95 Guenzer 01/09/96 AΧ 5,482,003 McKee et al. 05/07/96 5,514,484 Nashimoto **A**7 5,556,463 09/17/96 Guenzer 12/31/96 BΑ 5,588,995 Sheldon BB 5,670,798 09/23/97 Schetzina BC 5,733,641 03/31/98 Fork et al. BD 5,735,949 04/07/98 Mantl et al. BE 5,741,724 04/21/98 Ramdani et al. BF 5,810,923 09/22/98 Yano et al. BG 5.830.270 11/03/98 McKee et al. ВН 5,912,068 06/15/99 Jia 02/01/00 Wollesen 6,020,222 BI 04/04/00 6,045,626 Yano et al. BK 6,064,078 05/16/00 Northrup et al. BL 6,064,092 05/16/00 ВМ 6,096,584 08/01/00 Ellis-Monaghan et al. BN 6,103,008 08/15/00 McKee et al. ВО 6,136,666 10/24/00 å 6,174,755 01/16/01 Manning BQ 6,180,486 01/30/01 Leobandung et al.

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		IΑ	5,650,646	07/22/97	Summerfelt	1	1	
19		ΙΒ	5,656,382	08/12/97	Nashimoto			
-t		IC	5,659,180	08/19/97	Shen et al.			
-		D	5,661,112	08/26/97	Hatta et al.			
		ΙE	5,679,965	11/95	Schetzina		1	
		IF	5,725,641	03/10/98	MacLeod			
$\neg \neg$		IG	5,745,631	04/28/98	Reinker			
$\neg \uparrow$		IH	5,776,621	07/07/98	Nashimoto		. 1	
		11	5,777,350	07/07/98	Nakamura et al.			·
	-	IJ	5,789,845	08/04/98	Wadaka et al.			
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		IL	5,792,679	08/11/98	Nakato			
		M	5,796,648	08/18/98	Kawakubo et al.			
		IN	5,801,072	09/01/98	Barber .			
		0	5,812,272	09/22/98	King et al.			
		P	5,814,583	09/98	Itozaki et al.			
		Q	5,825,055	10/20/98	Summerfelt	1		
1		IR	5,827,755	10/27/98	Yonchara et al.			-
$\neg \neg$		S	5,833,603	11/10/98	Kovacs et al.			-
T		T	5,838,035	11/17/98	Ramesh			
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	ľ	IV	5,846,846	12/08/98	Suh et al.			
	7	W	5,863,326	01/26/99	Nause et al.			
		Х	5,872,493	02/16/99	Ella			
		Υ	5,879,956	03/99	Seon et al.			
		Z	5,880,452	03/09/99	Plesko			
		JA	5,883,564	03/16/99	Partin .			
		JB .	5,907,792	05/25/99	Droopad et al.		\Box	
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		ID .	5,948,161	09/07/99	Kizuki		$oldsymbol{oldsymbol{\sqcup}}$	
		IE	5,959,879	09/28/99	Koo		_	·
		IF.	5,966,323	10/99	Chen et al.	$\bot \bot \bot \bot$		
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		IH .	6,022,140		Fraden et al.	\bot		
		1	6,022,410		Yu et al.	+		
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		K	6,028,853		Haartsen			
\bot		L	6,049,702		Tham et al.			
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		0	6,090,659		Laibowitz et al.	1-1-1		<u> </u>
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Form PTO 1449 (Modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE BANGE BANG ATTY DOCKET NO. SERIAL NO. 211618US99 09/910,753 **APPLICANT** LIST OF REFERENCES CITED BY APPLICANT Rudy M. EMRICK, et al. **FILING DATE GROUP** July 24, 2001 2826 **U.S. PATENT DOCUMENTS EXAMINER** DOCUMENT DATE NAME CLASS SUB FILING DATE INITIAL NUMBER IF APPROPRIATE CLASS KA 6,153,454 11/28/00 Krivokapic кв 6,191,011 02/01 Gilboa et al KC 6.204.737 03/20/01 Ella KD 6,224,669 05/01/01 Yi et al. KΕ 6,225,051 05/01/01 Sugiyama et al. ΚF 6,241,821 06/05/01 Yu et al. ĸG 6,265,749 07/24/01 Gardner et al. ĸН 6,313,486 11/01 Kencke et al. ΚÏ 6,316,832 11/13/01 Tsuzuki et al. ΚĴ 2002/0008234 01/02 Emrick ΚK 3,670,213 06/13/72 Nakawaga et al. KL 4,756,007 07/05/88 Qureshi et al. КМ 4,773,063 09/20/88 Hunsperger et al. KN 5.394,489 02/28/95 Koch KΩ 04/11/95 5,406,202 Mehrgardt et al. ΚP 5,528,067 06/18/96 Farb et al. ĸ 5,572,052 11/05/96 Kashihara et al. KR 5,767,543 06/16/98 Ooms et al. KS 6,175,497 01/16/01 Tseng et al. ζ 6,197,503 03/06/01 Vo-Dinh et al. ΚU 6,248,459 06/19/01 Wang et al. ΚV 6,252,261 06/26/01 Usui et al. KW 6,255,198 07/03/01 Linthicum et al. ΚX 6,268,269 07/31/01 Lee et al. 6,291,319 09/18/01 Yu et al. 6,316,785 11/13/01 Nunoue et al. 6,343,171 01/29/02 Yoshimura et al. В 4,965,649 10/23/90 Zanio et al. <u>.c</u> 6,253,649 05/01 Kawahara et al. 6,211,096 :D 04/01 Allman et al. Æ 6,239,449 05/29/01 Fafard et al. ĹF 2001/0013313 08/16/01 Droopad et al. 6,184,044 _G 02/06/01 Sone et al. LH 6,011,646 01/04/00 Mirkarimi et al. 5,227,196 07/13/93 ltoh 6,150,239 11/21/00 Goesele et al. ΙK 5,441,577 08/15/95 Sasaki et al. 4,459,325 07/10/84 Nozawa et al. Σ 4,392,297 07/12/83 Little 4,289,920 09/15/81 Hovel ιō 5,281,834 01/25/94 Cambou et al. 4,901,133 02/13/90 Curran et al. LΩ 5,514,904 05/07/96 Onga et al.

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	-			U.S. PATENT DOCUMENTS					
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100	MA	5,553,089	09/03/96	Seki et al.					
19	MB	5,528,057	06/18/96	Yanagase et al.					
	МС	6,229,159	05/08/01	Suzuki	\Box				
	MD	4,748,485	05/31/88	Vasudev					
	ME	4,984,043	01/08/91	Vinal					
	MF	5,754,319	05/19/98	Van De Voorde et al.					
	MG	6,108,125	08/22/00	Yano			- 1	_	
	МН	5,073,981	12/17/91	Giles et al.			\neg	_	
	MI	5,140,651	08/18/92	Soref et al.	1		-	\dashv	
	MJ	5,610,744	03/11/97	Ho et al.	++	\dashv	∸╂	\dashv	
	MK	6,362,017	03/26/02	Manabe et al.			-+		
- -	ML	6,242,686	06/05/01	Kishimoto et al.		-	\dashv		
	MM	5,689,123	11/18/97	Major et al.	 	\dashv	- +		
	MN	5,670,800	09/23/97	Nakao et al.			- -	-	·
	МО	5,067,809	11/26/91	Tsubota		\dashv		-	
	MP	5,596,205	01/21/97		•	-	-		
-	_			Reedy et al.		-	-		
	MQ	6,175,555	01/16/01	Hoole	++	_		-	
	MR	5',357,122	10/18/94	Okubora et al.	\dashv			\bot	<u></u>
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	MT	6,093,302	07/25/00	Montgomery	-	_			
+	MU	6,372,813	04/16/02	Johnson et al.		\perp	_		
 	MV	5,608,046	03/04/97	Cook et al.					
1	MW	5,955,591	09/21/99	imbach et al.	-				
	МХ	6,022,963	02/08/00	McGall et al.					
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	NA	5,479,317	12/26/95	Ramesh					
	NB	5,306,649	04/26/94	Hebert		1	\Box		
	NC	5,962,069	10/05/99	Schindler et al.		T.	\neg		
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	NI	5,610,744	03/11/97	Ho et al.		7	\top	╅	
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